BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS024024009-SF-8H

Description: 24.00 x 24.00 x 9.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin Heat Sink Attachment: superGRIP Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	12.94 °C/W	8.7 °C/W	7 °C/W	6.1 °C/W	5.5 °C/W	5 °C/W	4.7 °C/W
	Ducted Flow	5.7	4.8	4.2	3.8	3.6	3.3	3.2

Product Detail



